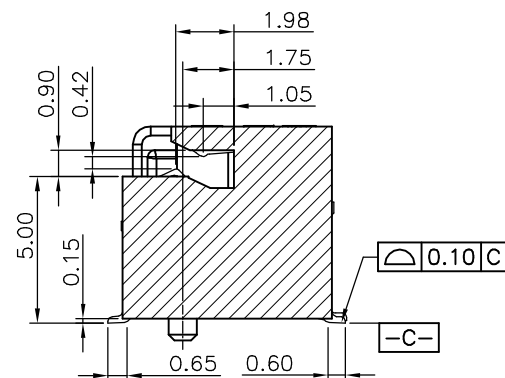
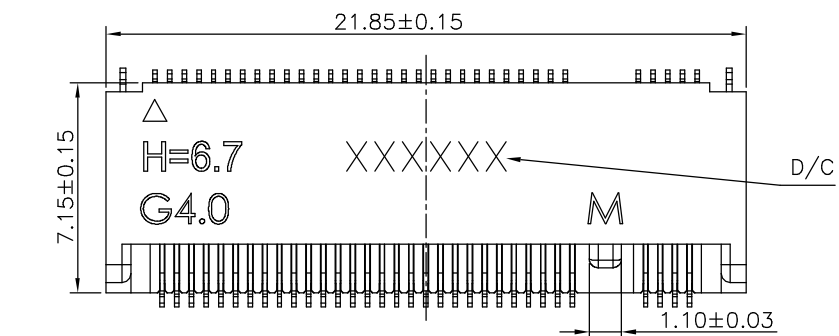
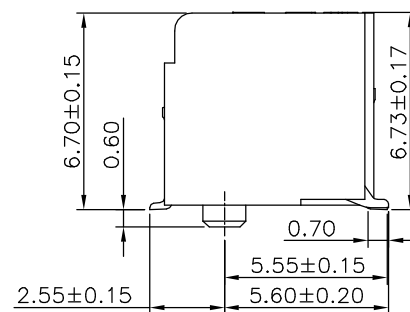




SEE SECTION 0-0



Notes:

1. MATERIAL SPECIFICATION:
1.1. HOUSING:LCP+40%GF,UL94V-0,COLOR:BLACK.
1.2. CONTACT:COPPER ALLOY.
1.3. PEG:S50C.

2. PLATING SPECIFICATION:

- 2.1. CONTACT:50u" MIN. NICKEL UNDER PLATING
OVER ALL. G/F PLATING ON SOLDER AREA.
GOLD PLATING ON CONTACT AREA:SEE TABLE
- 2.2. PEG:50u" MIN. NICKEL UNDER PLATING OVER ALL.
80u" MIN. MATTE TIN PLATING ON SOLDER AREA.

3. HF COMPLIANT, RoHS COMPLIANT.

4. DATE CODE: XX XX XX

 DAY
 WEEK
 YEAR

- ## 5. MECHANICAL PERFORMANCE:

- 5.1. DURABILITY: SEE TABLE

- ## 6. ELECTRICAL PERFORMANCE:

- 6.2. LLCR: INITIAL 55mΩ MAX.;FINAL Δ LLCR=20mΩ MAX.

7. IR REFLOW:

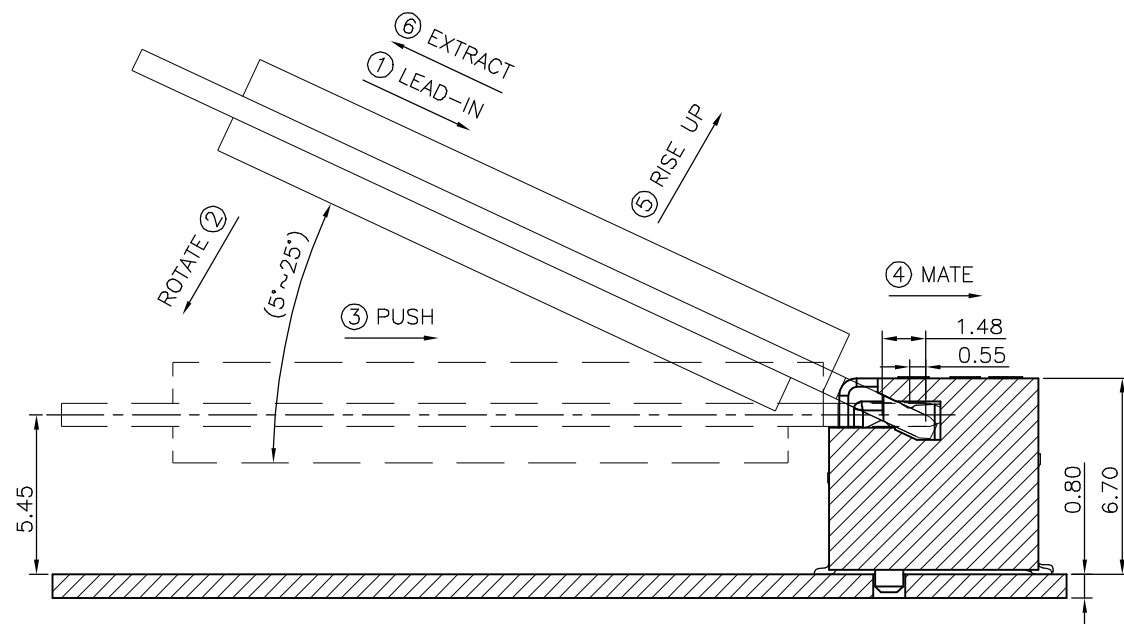
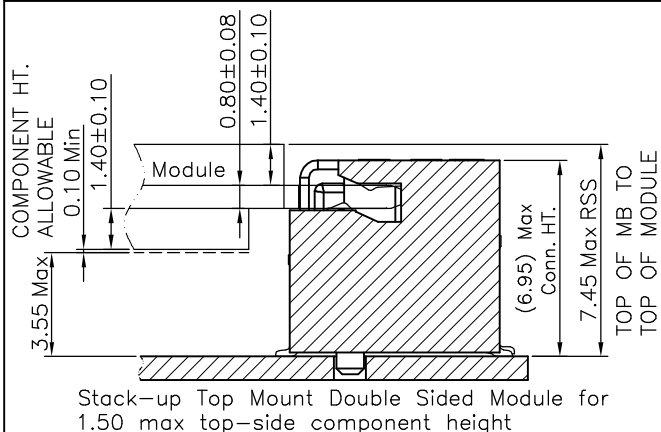
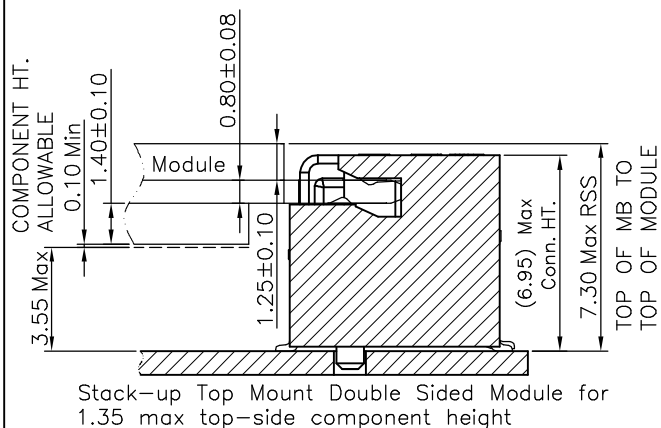
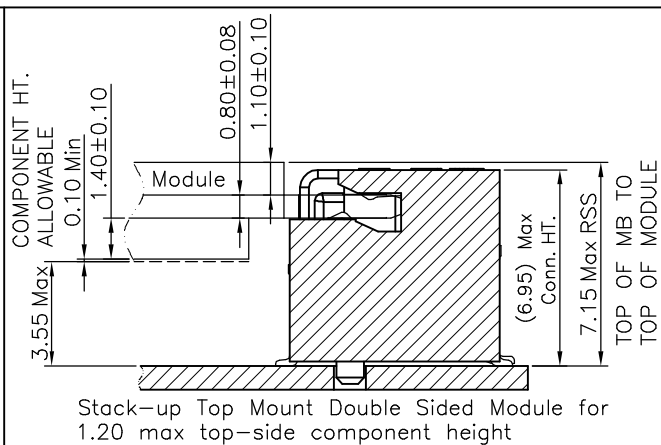
THE TEMPERATURE SHALL BE $260 \pm 5^\circ\text{C}$ MAINTAINING 10 ± 1 SECONDS.



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TOLERANCE:		DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME:	
X.X ±0.30				NGFF M.2 M KEY6.7H 0.5PH PCIe 4.0	
X.XX ±0.25					
X.XXX ±0.15					
X: ±2° X.X° ±0.5°		CHECKED BY:	DATE :	PART NO.	HYCW34M-05NGFF-670B
		马跃	2014-02-23	MOLD NO.	
UNIT: mm [inch]		APPROVED BY:	DATE :	DRAW NO:	HYC-2202281732
SCALE:1:1	SIZE: A4	邱敏	2014-02-23	SHEET NO.	1 OF 1

Assembly stack height schematic diagram



HOW TO MATE AND EXTRACT

MATE: ① → ④

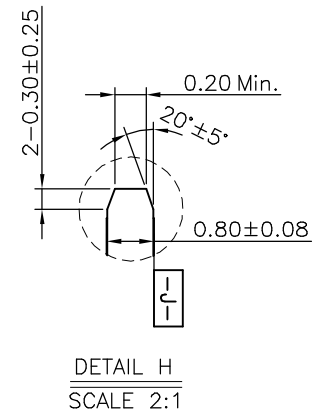
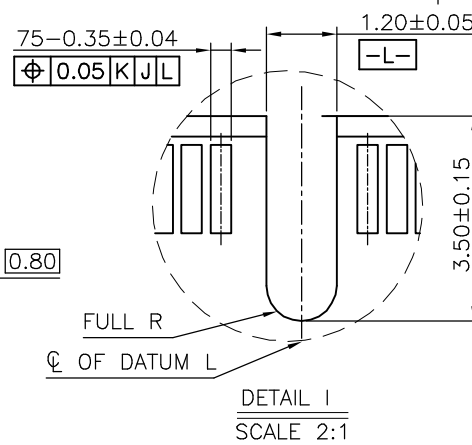
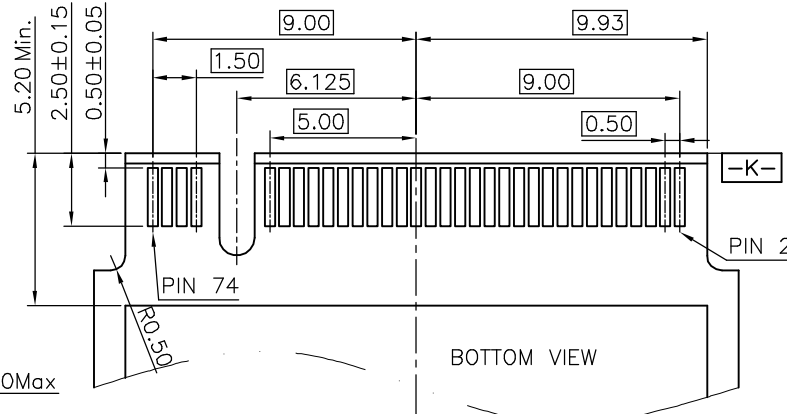
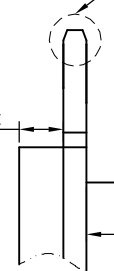
EXTRACT: ⑤ → ⑥

NOTE: Mating force will generate from step 3 to step 4.



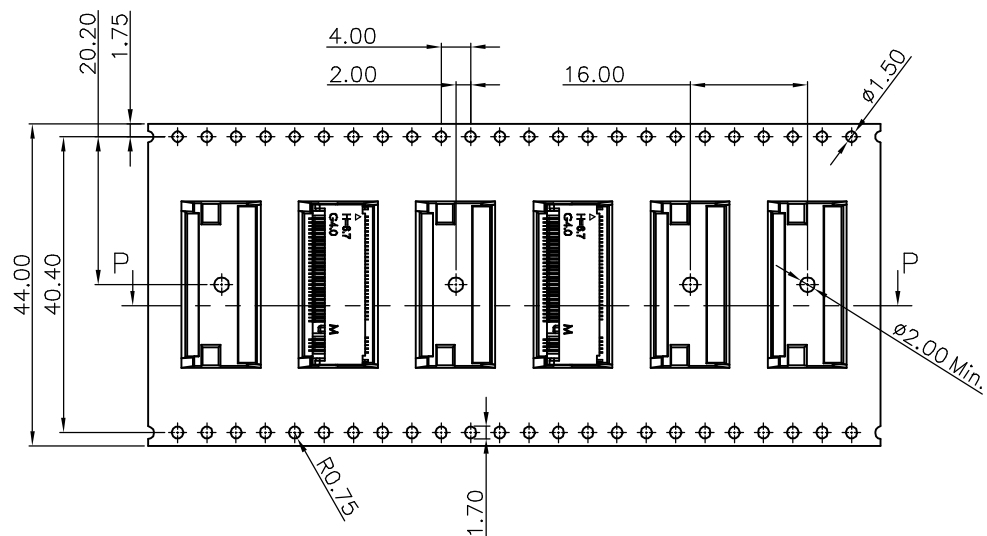
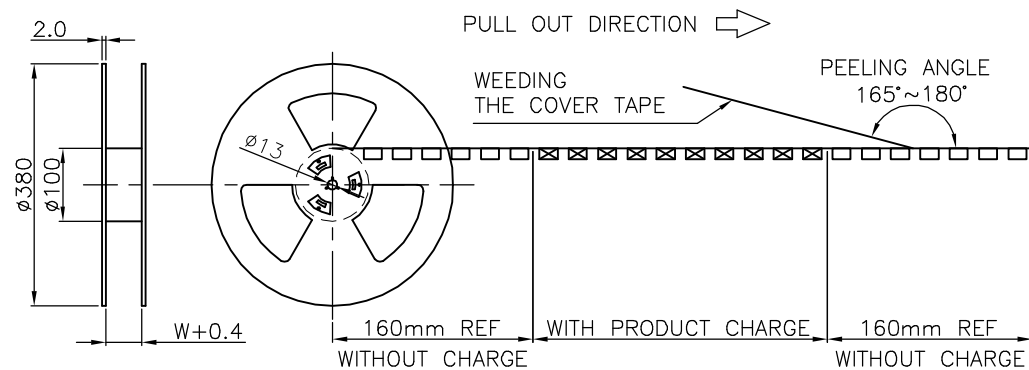
深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X' ±2° X.X' ±0.5°	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: NGFF M.2 M KEY 6.7H 0.5PH PCIe 4.0	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	HYCW34M-05NGFF-670B
 UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 邱敏	DATE : 2014-02-23	MOLD NO.	
			DRAW NO:	HYC-2202281732
			SHEET NO.	1 OF 1

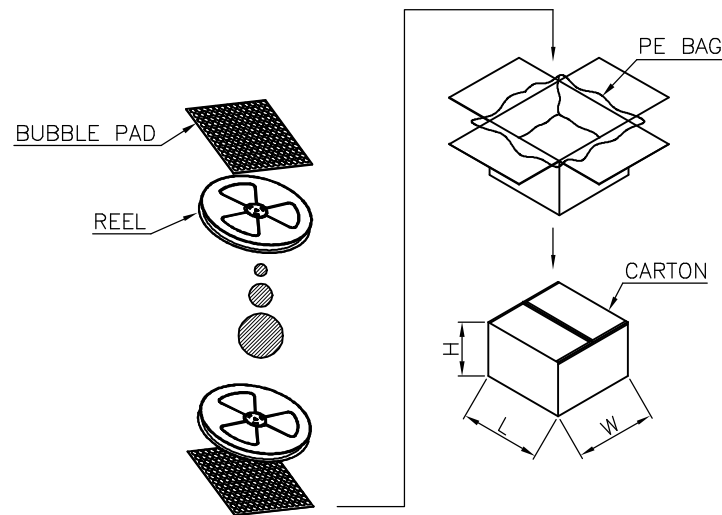


TYPE	3030	3042	2230	2242	2260	2280	22110
DIM.P	28.25	40.25	28.25	40.25	58.25	78.25	108.25

 深圳市华宇创精密电子有限公司			
TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X" ±2" X.X" ±0.5"		DRAWN BY : DATE : 陈一鸣 2014-02-23	
CHECKED BY: 马跃		DATE : 2014-02-23	
		PART NO. HYCW34M-05NGFF-670B	
MOLD NO.		DRAW NO: HYC-2202281732	
APPROVED BY: 邱敏		DATE : 2014-02-23	
SCALE:1:1 SIZE: A4		SHEET NO. 1 OF 1	



PULL OUT DIRECTION →



700	4200
PCS/REEL	PCS/CARTON



深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.* ±2* X.X* ±0.5* UNIT: mm [inch] SCALE:1:1 SIZE: A4	DRAWN BY :	DATE :	PART NAME:	
	陈一鸣	2014-02-23	包装图	
	CHECKED BY:	DATE :	PART NO.	
	马跃	2014-02-23	MOLD NO.	
	APPROVED BY:	DATE :	DRAW NO:	
	邱敏	2014-02-23	SHEET NO.	1 OF 1